February 2011

FSAV450 — 800MHz, 4-Channel, 2:1 Video Switch

Features

- -50dB Off Isolation at 30MHz
- -80dB Non-Adjacent Channel Crosstalk at 30MHz
- 3dB Bandwidth: 800MHz
- On Resistance: 4Ω (Typical)
- Low Power Consumption: 1µA (Maximum)
- Control Input TTL Compatible

Applications

 RGB Video Switch in LCD, Plasma and Projector Displays

Description

The FSAV450 is a high performance Quad Sinple-Pole Double-Throw (SPDT) (2-to-1 multiplexer/ demultiplexer) video switch designed specifically for switching high definition YPbPr and computer RGB (up to UXGA) signals. The bandwidth of this device is 800MHz (typical) which allows signals to pass with minimal edge and phase distortion. Image integrity is maintained with low crosstalk, high off-Isolation and low differential gain and phase. The low on resistance (4 Ω typical) minimizes signal insertion loss. Low voltage operation (3V), low power consumption (1 μ A maximum) and small scale packaging (including leadless DQFN) make this device ideal for a broad range of applications.

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FSAV450BQX	-40 to +85°C	16-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.5mm	Tape and Reel

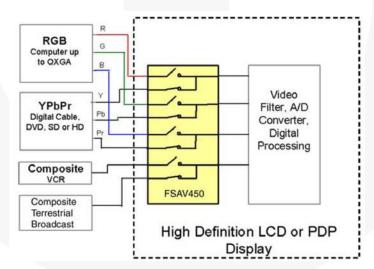


Figure 1. Typical Application Diagram

Pin Configurations

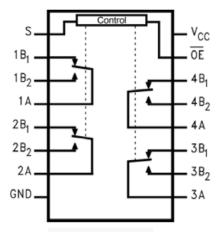


Figure 2. Analog Symbol

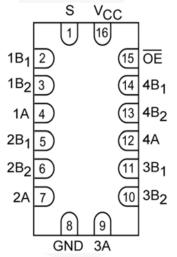


Figure 3. DQFN Pin Assignments

Pin Descriptions

Pin #	Name	Description
15	/OE	Bus Switch Enabled
1	S	Select Input
4, 7, 9, 12	A	Bus A
2, 3, 5, 6, 10, 11,13, 14	B ₁ -B ₂	Bus B
8	GND	Ground
16	V _{CC}	Supply Voltage

Truth Table

S	/OE	Function
Don't Care	HIGH	Disconnected
LOW	LOW	A=B ₁
HIGH	LOW	A=B ₂

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
V _{CC}	Supply Voltage	-0.5	+6.0	V
Vs	DC Switch Voltage	-0.5	+6.0	V
V _{IN}	DC Input Voltage ⁽¹⁾	-0.5	+6.0	V
I _{IK}	DC Input Diode Current, V _{IN} < 0V	-50		mA
I _{OUT}	DC Output Sink Current		128	mA
I _{CC} /I _{GND}	DC V _{CC} / GND Current		±100	mA
T _{STG}	Storage Temperature Range	-65	+150	°C
ESD	Human Body Model, JESD22-A114		2000	V

Note

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parar	Min.	Max.	Unit	
V _{CC}	Power Supply		4.0	5.5	V
V _{IN}	Input Voltage		0	V _{CC}	V
V _{OUT}	Output Voltage		0	V _{CC}	V
	A A Louis Discount Fall Time	Switch Control Input	0	5	ns/V
t_r, t_f	Input Rise and Fall Time Switch I/O		0	DC "	TIS/ V
T _A	Operating Temperature, Free Air		-40	+85	°C

Note:

2. Unused control inputs must be held HIGH or LOW; they may not float.

^{1.} The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

DC Electrical Characteristics

Typical values are at T_A = +25°C.

Cumbal	Doromotor	Conditions	V (\(\)	T _A = -40 to +85°C			Units
Symbol	Parameter	Conditions	V _{cc} (V)	Min.	Тур.	Max.	Ullits
V _{ANALOG}	Analog Signal Range			0		2	V
V_{IK}	Clamp Diode Voltage	I _{IN} =-18mA	4.5			-1.2	V
V _{IH}	High-Level Input Voltage		4.5 to 5.5	2.0			V
V_{IL}	Low-Level Input Voltage		4.5 to 5.5			0.8	V
I	Input Leakage Current	$0 \leq V_{IN} \leq 5.5V$	5.5			±1.0	μΑ
I _{OFF}	Off-State Leakage Current	$0 \le A, B \le V_{CC}$	5.5			±1.0	μΑ
В	Switch On Resistance ⁽³⁾	$V_{IN}=1.0V, R_{I}=75\Omega, I_{ON}=13mA$	4.5		4	6	0
R _{ON}	Switch On Resistance	$V_{IN}=2.0V, R_{I}=75\Omega, I_{ON}=26mA$	4.5		5	7	Ω
I _{CC}	Quiescent Supply Current	V _{IN} =V _{CC} or GND, I _{OUT} =0	5.5			1	μΑ
Δl _{CC}	Increase in I _{CC} per Input	One Input at 3.4V Other Inputs at V _{CC} or GND	5.5			1.5	mA

Note:

3. Measured by the voltage drop between the A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the A or B pins.

AC Electrical Characteristics

Typical values are at V_{CC} =5.0V and T_A = +25°C.

Symbol Parameter		Conditions	V _{cc}	T _A =	:-40 to+8	35°C	Units	Figure
Syllibol	Parameter	Conditions	V CC	Min.	Min. Typ. Max.		Units	rigule
	Turn On Time S to Bus B	VB=2V	4.5 to 5.5		4.0	6.0	ns	Figure 11,
t _{ON}	Output Enable Time OE to A or B	V D=2 V	4.5 (0 5.5		3.5	5.5	115	Figure 12
	Turn Off Time S to Bus B				1.5	3.5		Figure 11,
t _{OFF}	Output Disable Time OE to A or B			1.5	3.5	ns	Figure 12	
D_G	Differential Gain	$R_L=75\Omega$, f=3.58MHz	4.5 to 5.5		0.2		%	Figure 5
D_P	Differential Phase	$R_L=75\Omega$, f=3.58MHz	4.5 to 5.5		0.1		0	Figure 6
O _{IRR}	Non-Adjacent Off Isolation	R _L =75Ω, f=30MHz	4.5 to 5.5		-50		dB	Figure 7, Figure 13
X _{TALK}	Non-Adjacent Channel Crosstalk	$R_L=75\Omega$, f=30MHz	4.5 to 5.5		-80		dB	Figure 8, Figure 14
B _W	-3dB Bandwidth	$R_L=50\Omega$	4.5 to 5.5		800		MHz	Figure 4, Figure 15
		$R_L=75\Omega$			650			Figure 15

Capacitance

Typical values are at T_A = +25°C.

Symbol	Parameter	Conditions	Тур.	Units
C _{IN}	Control Pin Input Capacitance	V _{CC} =0V	3.0	рF
C _{ON}	A/B On Capacitance	V _{CC} =5.0V, /OE=0V	8.5	pF
C _{OFF}	Port B Off Capacitance	V _{CC} = /OE=5V	3.0	рF

AC Characteristics

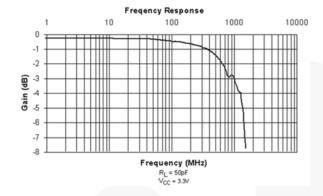


Figure 4. Gain vs. Frequency

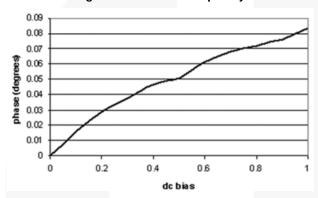


Figure 6. Differential Gain vs. DC bias

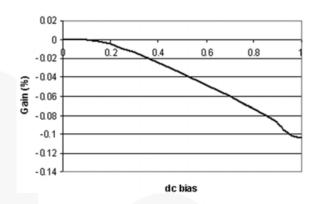


Figure 5. Differential Gain vs. DC bias

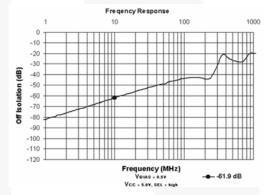


Figure 7. Off Isolation

AC Characteristics

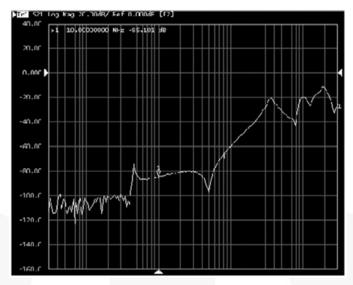


Figure 8. Off Crosstalk vs. Frequency

RON Switch Characteristics

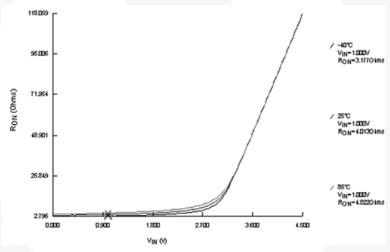


Figure 9. R_{ON} Switch On Resistance, I_{ON}=13mA

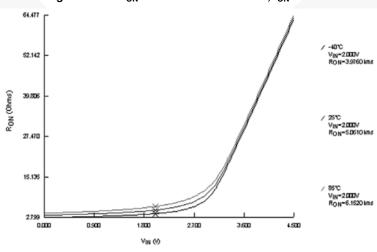
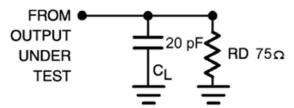


Figure 10. R_{ON} Switch On Resistance, I_{ON}=26mA

AC Loadings and Waveforms



Notes:

- 4. Input drive by 50Ω source terminated in 50Ω .
- 5. C includes load and stray capacitance.
- 6. Input PRR=1.0MHz, tw=500ns.

Figure 11. AC Test Circuit

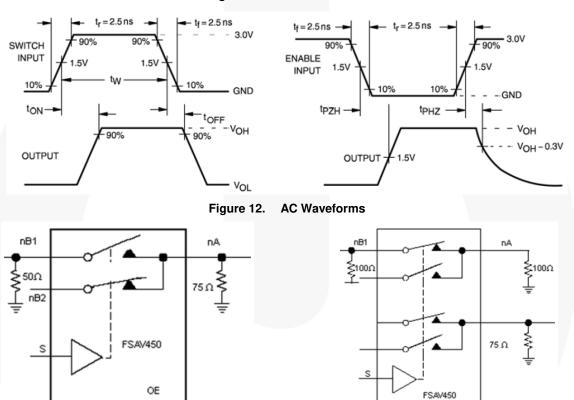


Figure 13. Off Isolation Test

Figure 14. Crosstalk

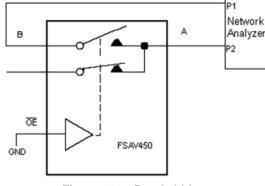
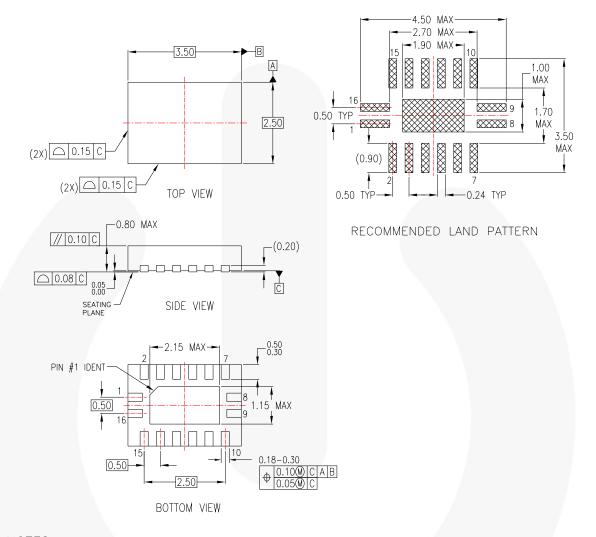


Figure 15. Bandwidth

Physical Dimensions



NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AB
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

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Figure 16. 16-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241

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